Begin development



To prepare your workstation for software development, power off the kit, remove the microSD card and insert it into your Ubuntu Linux workstation (adapter maybe required). If your workstation does not include an SD slot, USB SD card adapters are readily available. Follow the instructions to the right

Linux Software Development Kit Install the Linux SDK from the START HERE partition (the latest version of the SDK can be downloaded from TI's website).

If you need help on setting up a Linux Host PC, please visit www.ti.com/startyourlinux.

Connect the supplied USB debug cable to your AM572x processor board (as shown in Step 2). Connect the other end to your PC.

Connect an Ethernet cable (not included) to the top RJ-45 jack on the AM572x processor board. Connect the other end of the cable to an Internet-enabled router or Ethernet switch.



For more information on AM527x processors, including: How Tos

- User Guide
- Software

Please visit www.ti.com/am57x and www.ti.com/am572xevm

For support questions, please contact: support@ti.com or www.ti.com/e2e.

Design Files

Provide feedback: Take this survey and tell us about your experience using the AM572x EVM: www.ti.com/survey

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SPRW275

AM572x Evaluation Module **Quick Start Guide**



For more information: www.ti.com/am572xevm

TEXAS INSTRUMENTS



Caution Caution Hot surface. Contact may cause burns. Do not touch.

Welcome to the AM572x General Purpose (GP) Evaluation Module (EVM) Quick Start Guide. This guide is designed to help you through the initial setup of the EVM. This EVM allows you to experience Linux® and other operating systems (OSs) that showcase the AM572x Cortex[®]-A15 and TI C66x processors, 3D graphics, high-definition video processing and more. The AM572x EVM contains the following:

- Hardware
- Sitara[™] AM572x Cortex-A15 processor
- TPS659037 power management I/C
- 7" capacitive touch LCD
- 2GB DDR3L
- Camera module
- On-board eMMC
- Audio input and output
- SATA, USB 3.0, Ethernet and HDMI connectors
- Expansion capability

- Printed documents
- AM572x GP EVM Quick Start Guide (this document)
- Terms and conditions
- Miscellaneous
- µSD card with Linux SDK
- USB-to-serial debug cable
- HDMI cable for optional external display
- LCD brackets





Plug in the camera board

(included) as shown.



Confirm the jumpers J3, J4, J6 are jumpered across positions 2 and 3 (closest to edge of board).



Connect the supplied USB to serial cable to the processor board as shown (for simplicity only the processor board is shown).



Connect a +12VDC power supply (not included) with 0 output current rating of 5.0 Amp, positive inner and negative outer terminals, female barrel 5.5 × 2.5 mm (recommended power supply is GlobTek GTM91099-60VV-T2. or equivalent).



Insert the Linux SD card into the AM572x EVM processor board (standoffs shown for illustrative purposes, brackets are included with the kit).







To turn on, press and release power button (S1) or auxiliary power button. To turn off, press and hold the same button for 15 sec. Do not unplug the power supply to turn off the board, as it may cause damage.





You are now ready to explore the Linux demos which include various example applications. Click on any icon to start the demo.

(Continued)

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